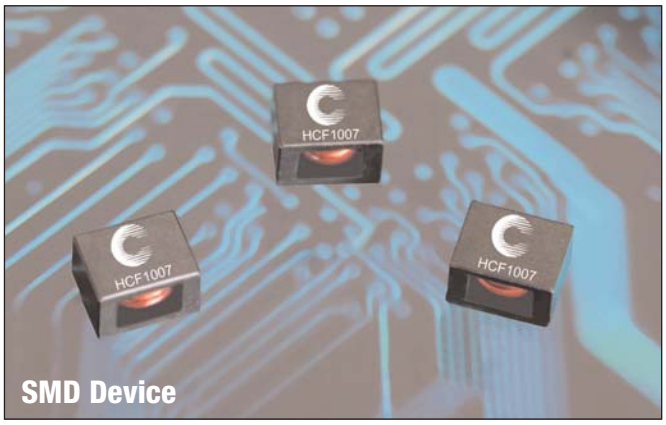
COILTRONICS®

High Current, High Frequency, Power Inductors

HCF1007 Series



Description

- Halogen free
- 125°C maximum total temperature operation
- 10.3 x 8.1 x 6.65mm surface mount package
- Ferrite core material
- Secure 3 terminal mounting
- High current carrying capacity, low core losses
- Controlled DCR tolerance for sensing circuits
- Inductance range from 0.3µH to 10.0µH
- Current range from 5.3 to 48 Amps
- Frequency range up to 1MHz
- RoHS compliant

Applications

- Point-of-load modules
- Multi-phase regulators
- Voltage Regulator Module (VRM)
- Desktop and server VRMs and EVRDs
- Data networking and storage systems
- Notebook regulators
- Graphics cards and battery power systems
- DCR current sensing

Environmental Data

- Storage temperature range: -40°C to +125°C
- Operating temperature range: -40°C to +125°C (ambient plus self-temperature rise)
- Solder reflow temperature: J-STD-020D compliant

Packaging

- Supplied in tape and reel packaging, 700 parts per 13" diameter reel

Product Specifications

Part Number[7]	OCL[1] µH ± 20%	FLL[2] Min (µH)	I_{rms}[3] Amps	$I_{sat}1$[4] Amps @25°C	$I_{sat}2$[5] Amps @125°C	DCR mΩ @20°C	K-factor[6]
HCF1007-R30-R	0.30	0.21	30	48	35	0.90±10%	279.9
HCF1007-R42-R	0.42	0.30	26	45	36	1.30±7%	186.6
HCF1007-R56-R	0.56	0.40	26	36	28	1.30±7%	186.6
HCF1007-R68-R	0.68	0.49	26	29	23	1.30±7%	186.6
HCF1007-1R0-R	1.0	0.72	16	26	21	2.65±6%	139.9
HCF1007-1R5-R	1.5	1.08	13	22	17	4.15±6%	112.0
HCF1007-2R2-R	2.2	1.57	10.7	18	14	6.35±6%	93.30
HCF1007-3R3-R	3.3	2.37	10	14.5	11	7.50±6%	79.97
HCF1007-4R7-R	4.7	3.38	9.4	12	8.9	8.65±6%	69.97
HCF1007-5R6-R	5.6	4.03	9.4	9.4	7.5	8.65±6%	69.97
HCF1007-6R8-R	6.8	4.90	9.4	7.8	6.1	8.65±6%	69.97
HCF1007-100-R	10.0	7.20	9.4	5.3	4.2	8.65±6%	69.97

1 Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10V_{rms}, 0.0Adc

2 Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1V_{rms}, $I_{sat}1$

3 I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

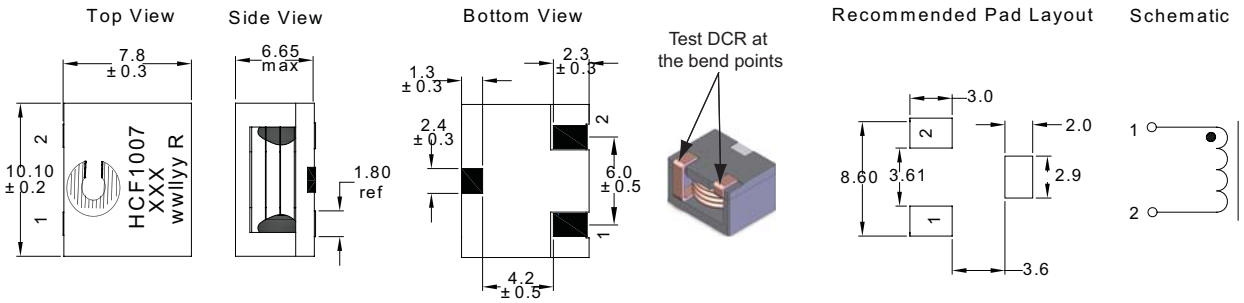
4 $I_{sat}1$: Peak current for approximately 20% rolloff at +25°C.

5 $I_{sat}2$: Peak current for approximately 20% rolloff at +125°C.

6 K-factor: Used to determine B_{p-p} for core loss (see graph). $B_{p-p} = K * L * \Delta I$. B_{p-p}:(Gauss), K: (K-factor from table), L: (Inductance in µH), ΔI (peak-to-peak ripple current in amps).

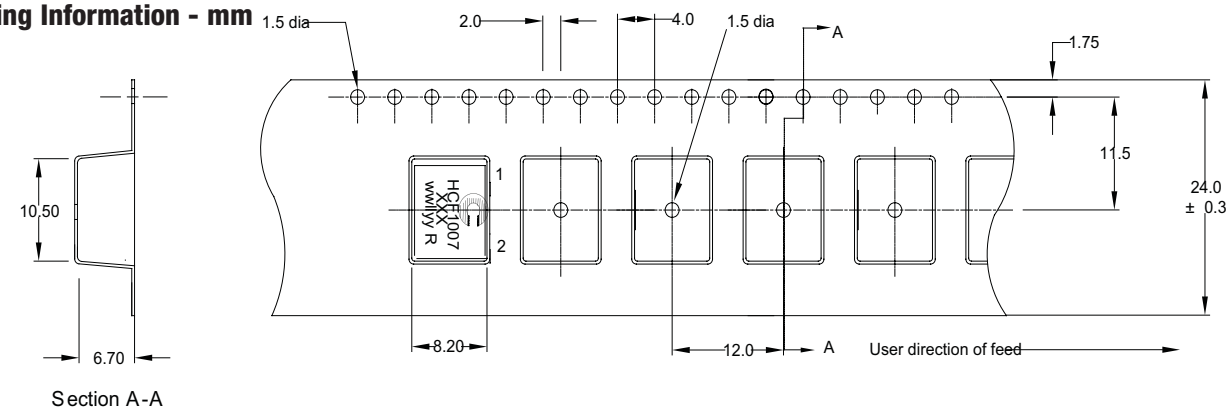
7 Part Number Definition:HCF1007-xxx-R
- HCF1007 = Product code and size
- xxx= Inductance value in µH, R = decimal point. If no "R" is present then third character =# of zeros
- -R suffix = RoHS compliant

Dimensions - mm



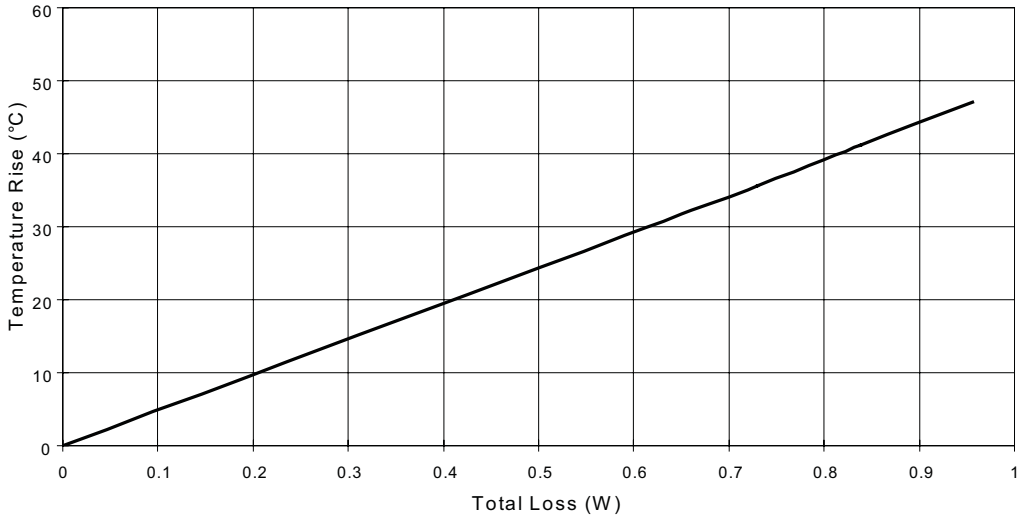
Part Marking: Coiltronics logo HCF1007 xxx = Inductance value in µH. (R = Decimal point). If no "R" is present, then last character is # of zeros yyllww = Date code R = Revision level

Packaging Information - mm

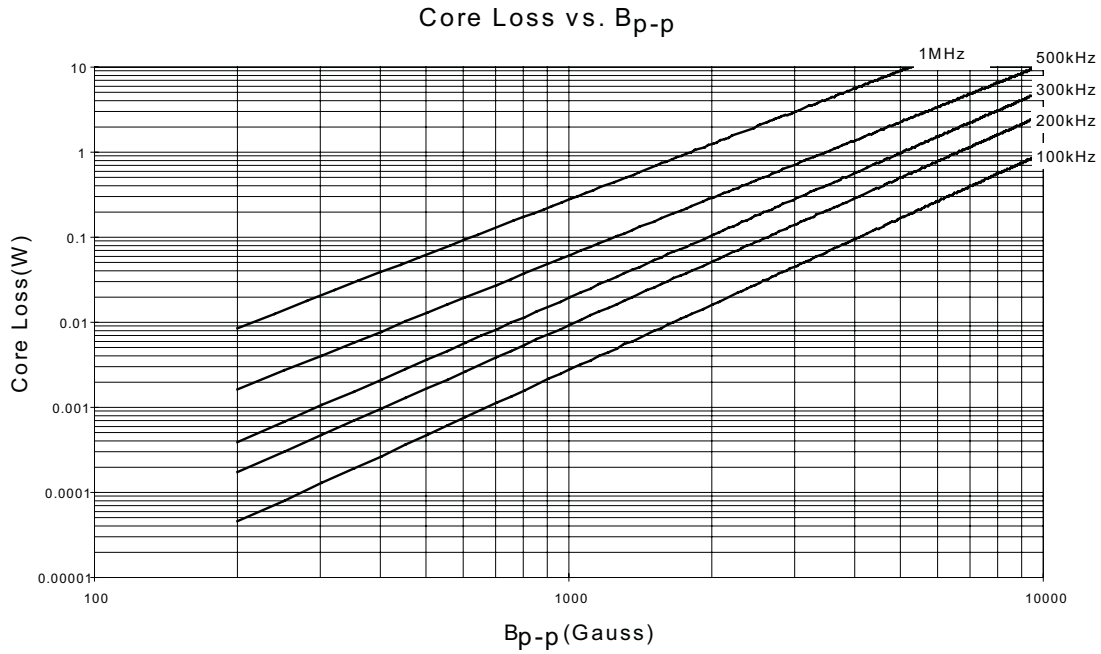


Supplied in tape-and-reel packaging, 700 parts per reel, 13" diameter reel.

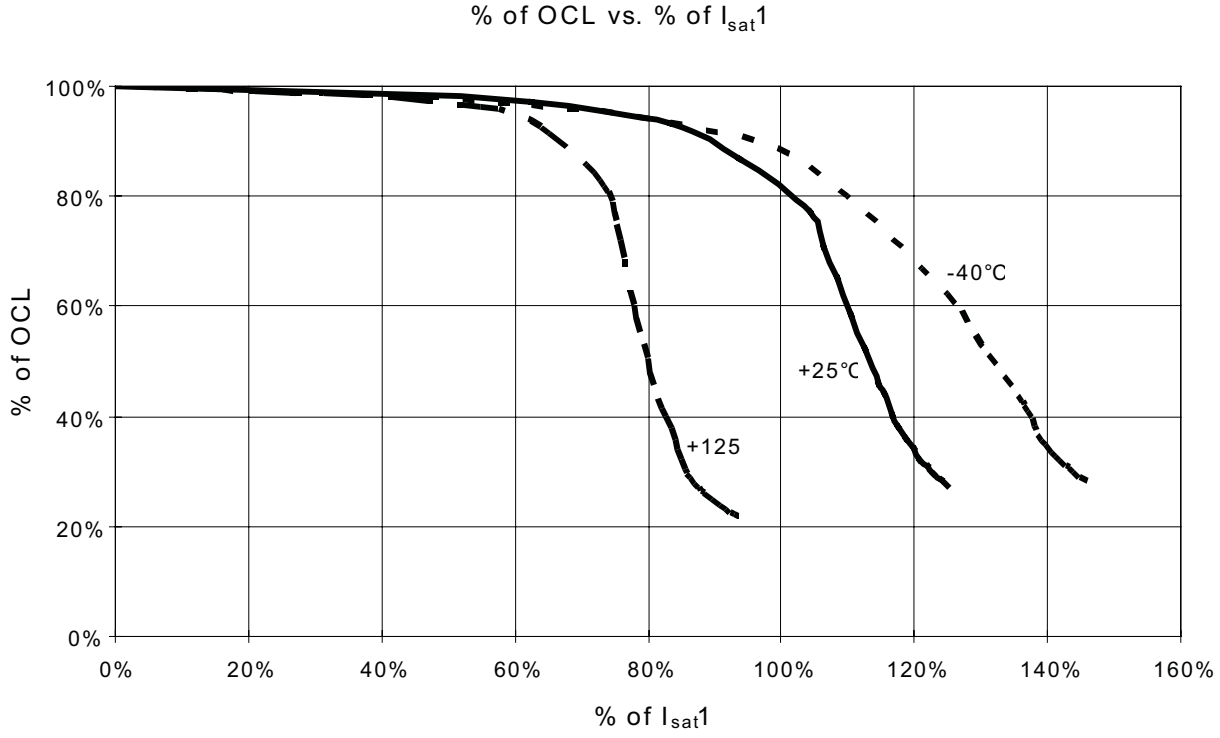
Temperature Rise vs. Total Loss



Core Loss



Inductance Characteristics



Solder Reflow Profile

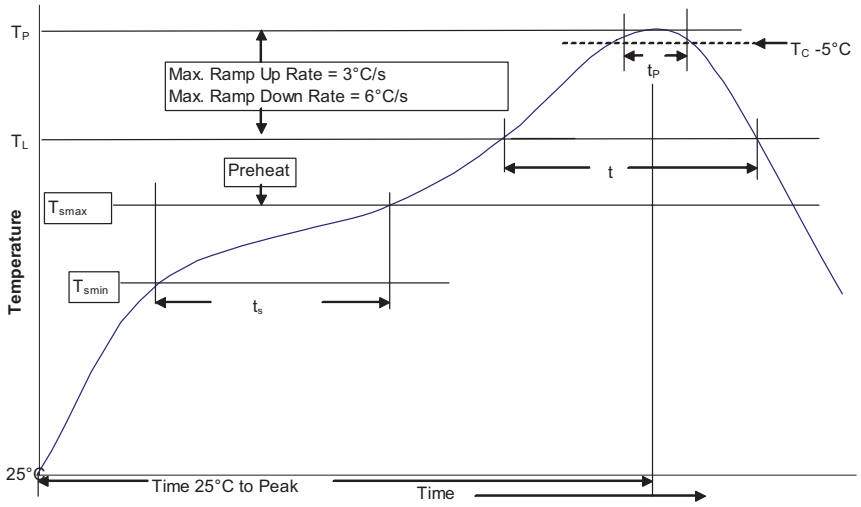


Table 1 - Standard SnPb Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ ≥350
<2.5mm	235°C	220°C
≥2.5mm	220°C	220°C

Table 2 - Lead (Pb) Free Solder (T_C)

Package Thickness	Volume mm³ <350	Volume mm³ 350 - 2000	Volume mm³ >2000
<1.6mm	260°C	260°C	260°C
1.6 – 2.5mm	260°C	250°C	245°C
>2.5mm	250°C	245°C	245°C

Reference JDEC J-STD-020D

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder
Preheat and Soak	• Temperature min. (T_{smin})	100°C	150°C
	• Temperature max. (T_{smax})	150°C	200°C
	• Time (T_{smin} to T_{smax}) (t_s)	60-120 Seconds	60-120 Seconds
Average ramp up rate T_{smax} to T_p		3°C/ Second Max.	3°C/ Second Max.
Liquidous temperature (T_L) Time at liquidous (t_L)		183°C 60-150 Seconds	217°C 60-150 Seconds
Peak package body temperature (T_P)*		Table 1	Table 2
Time (t_p)** within 5 °C of the specified classification temperature (T_C)		20 Seconds**	30 Seconds**
Average ramp-down rate (T_p to T_{smax})		6°C/ Second Max.	6°C/ Second Max.
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.

* Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

North America
Cooper Electronic Technologies
1225 Broken Sound Parkway NW
Suite F
Boca Raton, FL 33487-3533
Tel: 1-561-998-4100
Fax: 1-561-241-6640
Toll Free: 1-888-414-2645

Cooper Bussmann
P.O. Box 14460
St. Louis, MO 63178-4460
Tel: 1-636-394-2877
Fax: 1-636-527-1607

Europe
Cooper Electronic Technologies
Cooper (UK) Limited
Burton-on-the-Wolds
Leicestershire • LE12 5TH UK
Tel: +44 (0) 1509 882 737
Fax: +44 (0) 1509 882 786

Cooper Electronic Technologies
Avda. Santa Eulalia, 290
08223
Terrassa, (Barcelona), Spain
Tel: +34 937 362 812
+34 937 362 813
Fax: +34 937 362 719

Asia Pacific
Cooper Electronic Technologies
1 Jalan Kilang Timor
#06-01 Pacific Tech Centre
Singapore 159303
Tel: +65 278 6151
Fax: +65 270 4160